

The Edge646 is an integrated trinary driver, window comparator, and switch matrix pin electronics solution manufactured in a wide voltage CMOS process. It is designed for automatic test equipment and instrumentation where cost, functional density, and power are all at a premium.

The tristatable driver is capable of generating 3 levels one for a logic high, one for a logic low, and one for either a termination voltage or a special programming voltage.

The on-board window comparator effectively determines whether the DUT is in a high, low, or intermediate state.

The switches are included to allow such functions as PMU, pull up, and pull down connections.

The Edge646 is intended to offer an extremely low leakage, low cost, low power, small footprint, per pin solution for 100 MHz and below pin electronics applications.

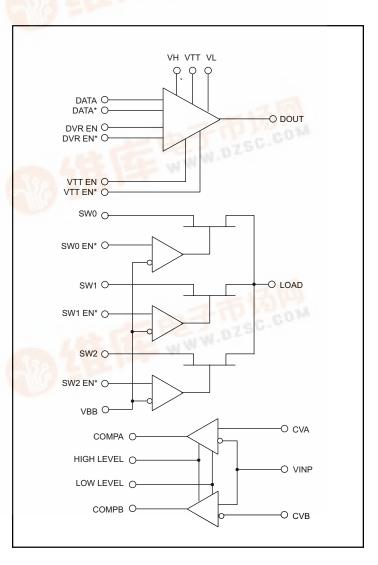
捷多邦,专业PCB打样工厂,24小时加急出售dge646 Pin Electronics Driver, Window **Comparator, and Switch Matrix**

Applications

Low Cost Automatic Test Equipment



Functional Block Diagram



Features

- 100 MHz Operation
- 12V I/O Range
- **Programmable Output Levels**
- Flex In digital Inputs (Technology Independent)
- Three Level Driver
- Extremely Low Leakage Currents (~0 nA)
- WWW.DZSC.COM Small Footprint (32 Pin, 7 mm X 7 mm, **TOFP** Package)



SEMTECH

Edge646

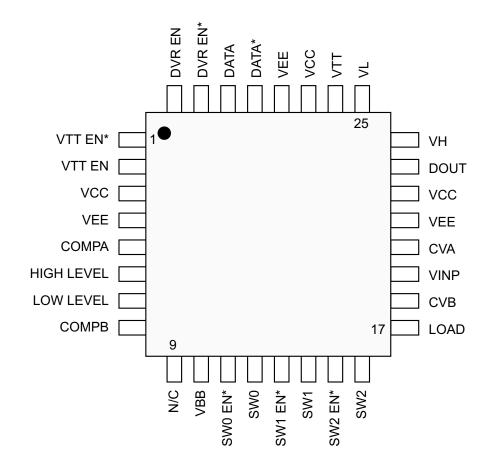
EDGE HIGH-PERFORMANCE PRODUCTS

PIN Description

| Pin Name | Pin # | Description | | |
|-----------------------------|----------------|---|--|--|
| Driver | <u>I</u> | ł | | |
| DATA / DATA* | 30, 29 | Digital input that determines the high/low status of the driver when it is enabled. | | |
| DVR EN / DVR EN* | 32, 31 | Digital input that enables and disables the driver, or places t driver in the VTT state. | | |
| VTT EN / VTT EN* | 2, 1 | Digital input that determines whether DVR EN* places the drive in a high impedance state or actively drives to the VTT level. | | |
| DOUT | 23 | Driver Output. | | |
| VH, VL, VTT | 24, 25, 26 | Unbuffered analog inputs that set the voltage level of a logical 1, 0, or VTT at the driver output. | | |
| VBB | 10 | Analog input pin which establishes the threshold for all single- ended digital input signals. | | |
| Comparator | | | | |
| VINP | 19 | Analog window comparator input. | | |
| CVA, CVB | 20, 18 | Analog DC comparator inputs that set the threshold levels for the window comparator. | | |
| COMPA, COMPB | 5, 8 | Digital comparator outputs. | | |
| LOW LEVEL HIGH LEVEL | 7 6 | Voltage inputs that establish the digital low and high levels of the comparator outputs. | | |
| Switch Matrix | | | | |
| SWO EN*, SW1 EN* SW2 EN* | 11, 13 15 | TTL compatible inputs that activate switches 0, 1, 2, and 3. | | |
| SWO SW1 SW2 | 12 14 16 | Switch 0 Switch 1 Switch 2 | | |
| LOAD | 17 | Input pin that connects the DUT to the analog switches. | | |
| Power Supplies | • | | | |
| VCC | 3, 22, 27 | Positive analog power supply. | | |
| VEE | 4, 21, 28 | Negative analog power supply. | | |
| N/C | 9 | No Connect pin (leave floating). | | |



32-Pin, 7mm x 7mm TQFP



EDGE HIGH-PERFORMANCE PRODUCTS

Driver Description

Circuit Description

The Edge646 driver supports three distinct programmable driver levels; high, low, termination, and high impedance. There are no restrictions between any of these three levels in that all three may vary independently over the entire operating voltage range between VCC and VEE.

The DVR EN*, DATA, and VTT EN pins are digital inputs that control the driver (see Table 1). With DVR EN* low, DATA determines whether the driver will force VH or VL at DOUT. With DVR EN* high, VTT EN* controls whether the driver goes into high impedance or drives VTT..

| DVR EN* | VTT EN | DATA | DOUT |
|---------|--------|------|------|
| 1 | 0 | Х | HiZ |
| 1 | 1 | Х | VTT |
| 0 | Х | 0 | VL |
| 0 | Х | 1 | VH |

Table 1. Driver Truth Table

VH, VL, and VTT

VH, VL, and VTT define the logical "1", "O", and "termination" levels of the driver and can be adjusted anywhere over the range spanned by VCC to VEE. There is no restriction between VH, VL, and VTT, in that they can all vary independently over the entire voltage range determined by the power supply levels.

The VH, VL, and VTT inputs are unbuffered in that they also provide the driver output current, so the sources of these voltages must have ample current drive capability.

While VTT is referred to as the termination voltage, it may also be used as a very high "programming" level on many memory devices.

Driver Output Protection

The Edge646 is designed to operate in a functional testing environment where a controlled impedance (typically 50 Ω) is maintained between the pin electronics and the DUT. In general, there will be an external resistor at the driver

output which series terminates the transmission line to the DUT. In this environment, the driver can withstand a short to any legal DUT voltage for an indefinite period.

In a low impedance application with no additional output series resistance, care must be exercised and systems should be designed to check for this condition and tristate the driver if a short is detected.

The driver does NOT have on-chip short circuit protection or limitation circuitry.

VBB

VBB is an analog input which establishes the threshold for all single ended digital input signals. If SWO EN*, SW1 EN*, or SW2 EN* are more positive than VBB, these inputs are a digital "1". Conversely, if they are more negative than VBB, they are a "0".

All digital inputs are wide voltage comparator inputs, so they are technology independent. By establishing the appropriate VBB level for the switch control inputs, and the appropriate differential input levels for the driver digital control inputs, the Edge646 may be driven by TTL, ECL, CMOS, or any custom level circuitry.

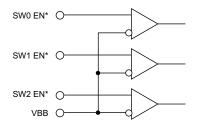


Figure 1. Driver Digital Inputs

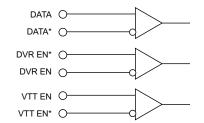


Figure 2. Driver Differential Digital Inputs



Receiver Functionality

The Edge646 supports an on-board window comparator. CVB and CVA are high impedance analog inputs which establish the threshold voltages. COMPA and COMPB are the digital outputs which reflect the real time status of VINP. Table 2 summarizes the relationship between the threshold levels, VINP, and the output signals.

| VINP | СОМРА | СОМРВ |
|------------|-------|-------|
| VINP < CVA | 1 | x |
| VINP > CVA | 0 | x |
| VINP < CVB | X | 0 |
| VINP > CVB | X | 1 |

Table 2. Comparator Truth Table

Comparator Outputs

The comparator outputs are 50Ω output impedance nontristatable drivers designed to cleanly drive 50Ω transmission lines without requiring any external series termination resistors. Input pins LOW LEVEL and HIGH LEVEL establish the logic 0 and 1 levels respectively. In normal operation, LOW LEVEL would be connected to ground and HIGH LEVEL would be connected to a system VDD supply, producing CMOS digital swings at the output.

However, the comparator outputs are technology independent in that they can drive PECL, 3V CMOS, ECL, LV CMOS, GTL, and custom levels by varying LOW LEVEL and HIGH LEVEL. For example, should a 3V swing be desired, HIGH LEVEL could be connected to a 3.0V power supply.

Notice that HIGH LEVEL and LOW LEVEL provide both the voltage level and the current for the comparator outputs. HIGH LEVEL and LOW LEVEL may be varied between +5V and -2V.

Load

The Edge646 provides a total of 3 analog switches. Individual switches vary in both their on resistance and their on/off time (see Table 4).

Like the driver digital inputs, the switch matrix control inputs SW0-3 EN* are technology independent as VBB determines their threshold level. The switch control is documented in Table 3.

| Control Inputs | Status |
|----------------|------------------|
| SW0 EN* = 1 | SW0 disconnected |
| SW0 EN* = 0 | SW0 connected |
| SW1 EN* = 1 | SW1 disconnected |
| SW1 EN* = 0 | SW1 connected |
| SW2 EN* = 1 | SW2 disconnected |
| SW2 EN* = 0 | SW2 connected |

Table 3. Switch Matrix Truth Table

| Switch | Rout | On/Off Time |
|--------|------|-------------|
| SWO | 50 Ω | 100 ns |
| SW1 | 50 Ω | 100 ns |
| SW2 | 50 Ω | 100 ns |

Table 4. Switch Matrix Characteristics

Do NOT leave any digital input pins floating.

SENTECH EDGE HIGH-PERFORMANCE PRODUCTS Application Information

Power Supplies Decoupling

A .1 μF capacitor is recommended between VCC and VEE.

In addition, solid VCC and VEE planes are recommended to provide a low inductance path for the power supply currents. These planes will reduce any inductive supply drops associated with swtiching currents on the power supply pins. If solid planes are not possible, then wide power busses are preferable.

Latchup Protection

The Edge646 has several power supply requirements to protect the part in power supply fault situations, as well as during power up and power down sequences. VCC must remain greater than or equal to VDD (external supply for the digital logic) at all times. Both VCC and VDD must always be positive (above ground), and VEE must always be negative (at or below ground).

The three diode configuration shown in Figure 3 should be used on a once-per-board basis.

VH, VL, and VTT Decoupling

As the VH, VL, and VTT inputs are unbuffered and must supply the driver output current, decoupling capacitors for these inputs are recommended in proportion to the amount of output current the application requires. In general, a surge current of 50 mA (5V swings series terminated with 50 Ω into a 50 Ω transmission line) are the maximum dynamic output currents the driver should see. The decoupling capacitors should be able to provide this current for the duration of the round trip time between the pin electronics and the DUT, and then recharge themselves before the next such transition would occur. Once this condition is satisfied, the VH, VL, and VTT supply voltages are more responsible for establishing the DC levels associated with each function and recharging the capacitors, rather than providing the actual dynamic currents required to drive the DUT transmission line.

Ideally, VH, VL, and VTT would each have a dedicated power layer on the PC board for the lowest possible inductance power supply distribution.

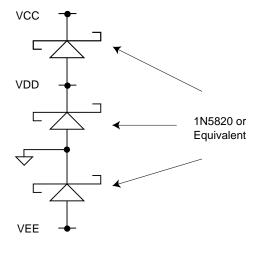
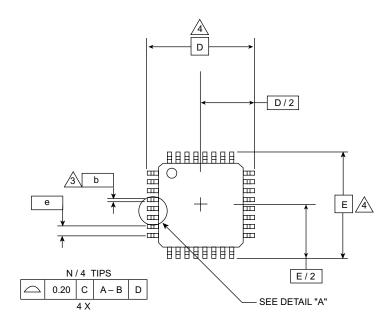


Figure 3. Power Supply Protection Scheme

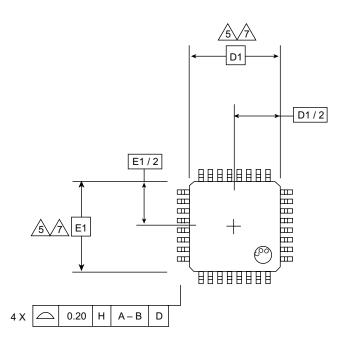
Warning: It is extremely important that the voltage on any device pin does not exceed the range of VEE -0.5V to VCC +0.5V at any time, either during power up, normal operation, or during power down. Failure to adhere to this requirement could result in latchup of the device, which could be destructive if the system power supplies are capable of supplying large amounts of current. Even if the device is not immediately destroyed, the cumulative damage caused by the stress of repeated latchup may affect device reliability.



TOP VIEW

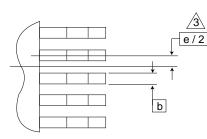


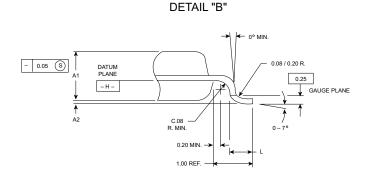




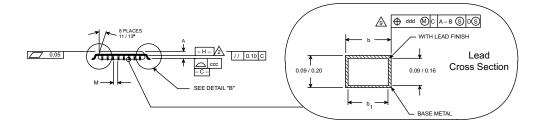
SENITECH EDGE HIGH-PERFORMANCE PRODUCTS Package Information (continued)

DETAIL "A"





SECTION C-C



Notes:

- 1. All dimensions and tolerances conform to ANSI Y14.5-1982.
- 2. Datum plane -H- located at mold parting line and coincident with lead, where lead exits plastic body at bottom of parting line.
- 3. Datums A-B and -D- to be determined at centerline between leads where leads exit plastic body at datum plane -H-.
- 4. To be determined at seating plane -C-.
- 5. Dimensions D1 and E1 do not include mold protrusion.
- 6. "N" is the total # of terminals.
- 7. These dimensions to be determined at the datum plane -H-.
- 8. Package top dimensions are smaller than bottom dimensions and top of package will not overhang bottom of package.
- Dimension b does not include dambar protrusion. Allowable dambar protrusion shall be 0.08 mm total in excess of the b dimension at maximum material condition. Dambar cannot be located on the lower radius or the foot.
- 10. Controlling dimension: millimeter.
- 11. Maximum allowable die thickness to be assembled in this package family is 0.30 millimeters.
- 12. This outline conforms to JEDEC publication 95, registration MO-136, variations AC, AE, and AF.

| | JEDEC VARIATION All Dimensions in Millimeters | | | | | |
|-----|--|------|------|------|--|--|
| | | AC | | | | |
| | Min. | Nom. | Max. | Note | | |
| Α | | | 1.60 | | | |
| A1 | 0.05 | 0.10 | 0.15 | | | |
| A2 | 1.35 | 1.40 | 1.45 | | | |
| D | | 9.00 | BSC. | 4 | | |
| D1 | | 7.00 | BSC. | 7,8 | | |
| Е | | 9.00 | BSC. | 4 | | |
| E1 | | 7.00 | BSC. | 7,8 | | |
| L | 0.45 | 0.60 | 0.75 | | | |
| М | 0.15 | | | | | |
| Ν | 32 | | | | | |
| е | | 0.80 | BSC. | | | |
| b | 0.30 | 0.37 | 0.45 | 9 | | |
| b1 | 0.30 | 0.35 | 0.40 | | | |
| CCC | | | 0.10 | | | |
| ddd | | | 0.20 | | | |

EDGE HIGH-PERFORMANCE PRODUCTS

Recommended Operating Conditions

| Parameter | Symbol | Min | Тур | Мах | Units |
|------------------------------|------------|-----|-----|------|-------|
| Positive Analog Power Supply | VCC | 6 | 8 | 12 | V |
| Negative Analog Power Supply | VEE | -5 | -4 | -3 | V |
| Total Analog Power Supply | VCC - VEE | 9 | | 12 | V |
| Comparator Output High Level | HIGH LEVEL | -2 | | +5 | V |
| Comparator Output Low Level | LOW LEVEL | -2 | | +5 | V |
| Junction Temperature | LT | | | +125 | °C |

Absolute Maximum Ratings

| Parameter | Symbol | Min | Тур | Max | Units |
|-------------------------------|-----------|------|-----|----------|-------|
| Total Analog Power Supply | VCC - VEE | 0 | | 13 | V |
| Positive Analog Power Supply | VCC | 0 | | 13 | v |
| Negative Analog Power Supply | VEE | -6 | | 0 | v |
| Analog Input Voltages | | VEE5 | | VCC + .5 | v |
| Digital Inputs | | VEE5 | | VCC + .5 | v |
| Ambient Operating Temperature | ТА | -55 | | +125 | oC |
| Storage Temperature | | -65 | | +150 | °C |
| Junction Temperature | ΤJ | | | +150 | oC |
| Soldering Temperature | | | | 260 | °C |

Stresses above listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Edge646

EDGE HIGH-PERFORMANCE PRODUCTS

DC Characteristics

Driver/Receiver Characteristics

| Parameter | Symbol | Min | Тур | Мах | Units |
|--|---|--|-----|--|------------------|
| Driver | | | | | |
| Programmable Driver Output Voltages Driver Output Swing | VH, VL, VTT VH - VL VH - VTT VTT - VLL | VEE VEE - VCC VEE - VCC VEE - VCC | | VCC VCC - VEE VCC - VEE VCC - VEE | V V V V |
| DC Driver Output Current | lout DC | -50 | | +50 | mA |
| AC Driver Output Current (Note 1) | lout AC | -220 | | +220 | mA |
| Output Impedance | Rout | 20 | 25 | 32 | Ω |
| DUT Pin Capacitance (Note 1) | Cout | | 13 | | pF |
| HiZ Leakage Current (Notes 1, 2) | lleak | | 0 | 4 | nA |
| Comparator | | | | | |
| Input Voltage | VINP | VEE | | VCC | v |
| Input Leakage Current (Notes 1, 2) | IBIAS | | 0 | 2 | nA |
| Input Capacitance (Note 1) | Cin | | 4 | | pF |
| Offset Voltage (Note 3) | VOS | 0 | | +200 | mV |
| Receiver Threshold (Note 3) | | VEE + 3.0 | | VCC - 2.0 | v |
| Threshold Bias Current (Note 1) | CVA, CVB | | 0 | 10 | nA |
| Digital Output High Level | HIGH LEVEL | -2 | | 5 | v |
| Digital Outptu Low Level | LOW LEVEL | -2 | | 5 | v |
| Digital Output Impedance (Note 4) | Rout | 31 | 37 | 45 | Ω |
| Digital Output Current Drive | Imax | -50 | | +50 | mA |
| Analog Switches (SW0, SW1, SW2) | | | | | |
| On Resistance | Ron | 30 | 36 | 44 | Ω |
| Voltage Range | | VEE | | VCC | v |
| LOAD HiZ Leakage Current (Notes 1, 2) | | | 0 | 4 | nA |
| DC Current Rating | | -30 | | +30 | mA |
| SW Capacitance | | | 10 | | pF |
| Total Power Supply Quiescent Positive Supply Current Quiescent Negative Supply Current | ICC_DC IEE_DC | | | 30 30 | mA mA |
| Total Leakage (Note 1) (DOUT + VINP + LOAD) | | | 0 | 10 | nA |
| Total Capacitance (Note 1) (DOUT + VINP + LOAD) | | | 27 | | pF |



DC Characteristics (continued)

Digital Inputs

DATA / DATA*, DVR EN* / DVR EN, VTT EN / VTT EN* SWO EN*, SW1 EN*, SW2 EN*

| Parameter | Symbol | Min | Тур | Max | Units |
|-----------------------------|--------------------------|-------|-----|-------------|----------------|
| Input High Voltage | Input - Input* | .8 | | 5 | V |
| Input Low Voltage | Input* - Input | .8 | | 5 | V |
| Input Current | IIN | | 0 | 1.0 | μA |
| Input Capacitance | DATA DRV EN VTT EN | | | 8 8 8 | pF pF pF |
| Digital Input Voltage Range | INPUT, INPUT* | -2.0* | | +5.0 | v |
| Digital Input Threshold | VBB | -1.4 | | 4.4 | V |

*-2V or (VEE + 2.0V), whichever is more positive.

Note 1: This parameter is guaranteed by design and characterization.

Note 2: Production testing is performed against a \pm 250 nA limit.

Note 3: Measured at OV.

Note 4: Measured at HIGH LEVEL = +3V, LOW LEVEL = 0V.

Edge646

EDGE HIGH-PERFORMANCE PRODUCTS

AC Characteristics

| Parameter | Symbol | Min | Тур | Мах | Units |
|--|-----------------|--------------------------|----------------------|-----------------------------|----------------------------|
| Driver | | | | | |
| Propagation Delay (Note 3) DATA IN to DOUT VTT EN to DOUT DVR EN* to DOUT (Active to HiZ) (Note 5) DVR EN* to DOUT (HiZ to Active) (Note 5) DATA to VTT Prop Delay Matching (Note 4) | | 7 7 7 7 -1.2 | 11 11 11 11 | 14 14 14 14 1.2 | ns ns ns ns ns |
| Minimum Pulse Width (3V Swing) | | | 4 | 5 | ns |
| Toggle Rate (Note 6) | Fmax | 100 | | | MHz |
| DOUT Output Rise/Fall Times (Notes 1, 4) 1V Swing (20% - 80%) 3V Swing (10% - 90%) 5V Swing (10% - 905) | | 1.0 | 1.2 1.5 2.0 | 1.6 2.0 3.5 | ns ns ns |
| Comparator | | | | | |
| Comparator Digital Outputs (Notes 2, 4) Rise Time (10% - 90%) Fall time (10% - 90%) VINP to COMPA, COMPB | tr tf Tpd | 4 | 1.5 1.5 8 | 2.5 2.5 11 | ns ns ns |
| Minimum Pulse Width | | | 4 | 5 | ns |
| Toggle Rate (Note 6) | Fmax | 100 | | | MHz |
| ∆Tpd vs. Overdrive 400 mV Overdrive 200 mV Overdrive | | | | 3.0 5.0 | ns ns |
| Tpd Rise, Tpd Fall Errors | | | | 2.0 | ns |
| Switch Matrix SW0, 1, 2 EN* to Switch On/ Off | | 10 | 20 | 50 | ns |

Note 1: Into 1M of 50Ω transmission line terminated with 1K Ω and 5 pF with the proper series termination resistor.

Note 2: LOW LEVEL = 0V, HIGH LEVEL = 3.3V.

Note 3: Measured at 2.5V with VH = +5V, VL = 0V.

Note 4: Guaranteed by design and characterization. This parameter is not tested in production.

Note 5: Tested with a 30 mA load.

Note 6: Guaranteed by characterization. (This parameter is tested in production against 40 MHz limits.)



Ordering Information

| Model Number | Package |
|--------------|------------------------------|
| E646ATF | 32-Pin TQFP |
| EVM646ATF | Edge646 Evaluation Module |

Contact Information

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